Adhesives for Plastics

Adhesives i	n this t	table	will b	ond	olasti	cs; ac	dditio	nal use	es are	potting and coating.				
Product	300-390 nm Light (Spot)	390-500 nm Light (Flood)	LED 385 nm Light	Heat	Activator	Moisture	2-Part Mixture	Also Bonds to Metal	Also Bonds to Glass	Features	Nominal Viscosity cP (20 rpm)	Durometer Hardness	Tensile at Break, MPa [psi]	Elongation at Break, %
product	s for	bond	ling								1			
3013	•	•	•					•		Moisture resistant; resilient	150	D70	18 [2,400]	70
3022	•	•	•							Hybrid acrylated urethane/epoxy for plastic and glass; high strength; tack free	500	D80	47 [6,800]	11
3025	•	•	•					•	•	General purpose	300	D65	17 [2,400]	70
3069	•	•	•							General purpose	450	D55	17 [2,400]	175
3086-T	•	•	•					•	•	UL-94V0 rated	6,700	D85	50 [7,250]	4
3099	•	•	•						•	Excellent glass, polycarbonate, and PMMA bonder	150	D75	19 [2,800]	170
3221-SC	•							•	•	General purpose; See-Cure technology	300	D55	12 [1,700]	220
MR290						•				Cyanoacrylate; resists moisture, humidity, & extreme temperatures	250-350	N/A	N/A	<2
RX50						•		•		Cyanoacrylate; rapid curing; high- performance grade	30-70	N/A	N/A	<2
form-in	-place	e/cur	e-in	-plac	ce ga	sket	s							
GA-105	•							•		Gel form-in-place gasket; soft and sticky	40,000	00-70	1.3 [190]	140
GA-140	•							•		Gel form-in-place gasket; tack free; low outgassing; resists moisture and chemicals	39,000	A35	1.5 [211]	167
product	s for	potti	ing											
3-20796	•	•								Flexible; fast, deep curing	3,200	D40	15 [2,200]	500
product	s for	coati	ing											
9-20557	•	•		•						Flexible for thermal cycling; MIL/IPC/UL recognized	2,500	D60	20 [3,000]	120
9481	•	•	•			•		•	•	Dual-Cure; light/moisture-cure conformal coating	125	D75	22 [3,200]	4

Typical Applications



Adhesion Chart for Plastic Substrates

This table shows adhesives from the previous page that are suggested for bonding with the following substrates.

• = Recommended adhesive ST = Surface treatment required in addition to adhesive (plasma, corona, UV, chemical, etc.)

Adhesives														
Bonds These Substrates	3013	3022	3025	3069	3086-T	3099	3221-SC	MR290	RX50	GA-105	GA-140	3-20796	9-20557	9481
Plastic Substrates	;	1	1	1	1			1			1	1	1	
ABS	•	•	•	•	•	•	•	•	•	•	•	•	•	•
CAP	•	-	-	•	•	•	-	-	-	•	•	•	•	•
HDPE/LDPE	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST		ST
PA 6-6	•	•	•	•	•	•	•	•	•	•	•	•	•	•
PC	•	•	•	•	•	•	•	•	•	•	•	•		•
PC/ABS	•	•	•	•		•	•			•	•			
PC/PCTG	•	•	•	•	•	•	•			•	•			
PCTG	•			•	•	•				•	•	•		•
PEEK	•									•	•	•	•	•
PEI		•	•	•	•	•	•			•	•	•		•
PET	•	•	•	•		•	•			•	•	•	•	
PETG		•	•	•		•	•			•	•	•	•	
PI	•	•	•	•	•	•	•			•	•	•		
РММА	•	•	•	•	•	•	•	•		•	•	•		•
PP	ST	ST	ST	ST	ST	ST	ST			•	•	ST		ST
PPO				•	•	•				•	•	•	•	•
PS	•	•	•	•	•	•	•			•	•	•		
PU	•	•	•	•	•	•	•			•	•	•		
PVC rigid	•	•	•	•	•	•	•	•	•	•	•	•	•	
PVC flexible	•	•	•	•	•	•	•	•	•	•	•	•	•	
SAN	•	•	•		•	•	•			•	•	•		•
TPU	•	•	•	•		•	•			•	•	•		
Bonds These Oth	er Subst	rates (r	netals,	ceramio	s, glass	;)		1			1			
ALUMINUM T3		•	•	•			•	•	•	•	•	•		
ALUMINUM 2024		•	•	•			•	•	•	•	•	•		
BRASS								•	•	•	•	•		
CERAMIC	•	•	•	•		•	•	•				•	•	•
C.R. STEEL								•	•	•	•		•	
COPPER								•	•	•	•	•	•	
FR-4		•	•	•	•	•	•	•	•	•	•	•	•	•
GLASS		•	•	•	•	•	•	•	•			•	•	
STAINLESS STEEL 13	•	•	•				•	•	•	•	•	•	•	
STAINLESS STEEL 304	•	•	•				•	•	•	•	•	•	•	

Adhesives for Metal and Glass

Adhesives in this	s table	will b	ond	meta	als a	nd g	lass;	; addit	onal uses are potting and thread locking.				
Product	300-390 nm Light (Spot)	390-500 nm Light (Flood)	LED 385 nm Light	Heat	Activator	Moisture	2-Part Mixture	Also Bonds to Plastic	Features	Nominal Viscosity cP (20 rpm)	Durometer Hardness	Tensile at Break, MPa [psi]	Elongation at Break, %
products fo	r bond	ding											
425	•								Clear; high strength; dishwasher safe	4,000	D80	43 [6,200]	7
429	•								Clear; low yellowing with UV exposure; high strength; resilient	2,500	D60	21 [3,000]	120
4-20418	•	•	•					•	Clear; low stress for glass bonding and laminating	450	D60	11.4 [1,650]	130
6-621	•	•	•	•	•			•	Multi-Cure [®] ; tough and resilient for interfacial and potting applications	800	D80	14 [2,100]	180
6-625 SV01-Rev A	•	•	•	•	•				Flexible; low stress; bridge bonding; no gap; structural reinforcement of spring clips; for chokes, ferrite cores, and transformers	10,000	D50	23 [3,400]	26
846-GEL				•	•				High-performance and high-strength structural adhesive; fixes < 60 seconds with 501-E activator; full cure 24 hours; also cures at 50°C for 15 minutes; free of acrylic acid, non-corrosive; for E- cores, ferrite, motor housings, and applications needing impact/shock resistance	30,000	N/A	N/A	N/A
8-20626				•	•				High-viscosity; epoxy structural adhesive; induction cure; black; fixes in 3 seconds/1.5 kW or 8 mins/180°C; for DC motors, magnet-to-can, and inconsistent gaps	110,000	D85	55 [8,000]	2
form-in-pla	ce/cui	r <mark>e-in</mark>	-pla	ce g	ask	ets							
GA-108	•							•	Form-in-place; soft/sticky; black	45,000	00-65	0.4 [63]	200
GA-111	•							•	Moisture and chemical resistant; form- in-place; no tack; black	40,000	A40	1.0 [140]	140
GA-120	•							•	Soft/tacky; self-leveling viscosity; low- durometer resin; quick curing; no silicone/solvents	1,000	00-50	0.14 [20]	110
GA-140	•							•	Soft; no tack; clear; low outgassing; quick curing; no silicone/solvents; conforms to intricate recesses; resists tears	39,000	A35	1.5 [211]	167
products fo	r pott	ing											
ER1196/ CT1196							•	•	2-part epoxy; flexible; long pot life	Resin: 15,500 Catalyst: 6,000	D60	5.7 [820]	19

Adhesion Chart for Metal and Glass Substrates

This table shows adhesives from the previous page that are suggested for bonding with the following substrates.

= Recommended adhesive
ST = Surface treatment required in addition to adhesive (plasma, corona, UV, chemical, etc.)

ST = Surface treatment required		to auries	ive (piasi		na, UV, C	nemical,	eic.)							
	Adhesives													
Bonds These Substrates	425	429	4-20418	6-621	6-625-SV01 Rev A	846-GEL	8-20626	GA-108	GA-111	GA-120	GA-140	ER1196/ CT1196		
Metal Substrates		1				1			1			1		
ALUMINUM T3	•	•	•	•	•	•	•	•	•	•	•	•		
ALUMINUM 2024	•	•	•	•	•	•	•	•	•	•	•	•		
BRASS	•		•	•	•	•	•	•	•	•	•	•		
COPPER	•			•	•	•	•	•	•	•	•	•		
C.R. STEEL	•	•	•	•	•	•	•	•	•	•	•	•		
FR-4	•	•		•	•	•		•	•	•	•	•		
STAINLESS STEEL 13	•	•		•	•	•	•	•	•	•	•	•		
STAINLESS STEEL 304	•	•		•	•	•	•	•	•	•	•	•		
Bonds These Other Substrat	tes (plastic	s, cerar	nics, gla	iss)										
ABS	•	•	•	•	•			•	•	•	•	•		
CAP	•		•	•				•	•	•	•	•		
CERAMIC	•			•	•	•						•		
GLASS	•	•	•	•	•	•	•					•		
HDPE/LDPE	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST		
PA/6-6			•	•	•			•	•	•	•	•		
PC			•	•				•	•	•	•	•		
PC/ABS								•	•	•	•	•		
PC/PCTG								•	•	•	•	•		
PCTG			•	•	•			•	•	•	•	•		
PEEK	•		•					•	•	•	•	•		
PEI			•	•				•	•	•	•	•		
PET			•	•	•			•	•	•	•	•		
PETG			•					•	•	•	•	•		
PI			•	•	•			•	•	•	•	•		
РММА	•		•	•				•	•	•	•	•		
PP	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	ST	•		
PPO			•					•	•	•	•	•		
PS			•					•	•	•	•	•		
PU				•	•			•	•	•	•	•		
PVC rigid	•	•	•	•	•			•	•	•	•	•		
PVC flexible		•	•	•	•			•	•	•	•	•		
SAN		•	•	•				•	•	•	•	•		
TPU		•	•					•	•	•	•	•		